## SiSS61DN

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**Vishay Siliconix** 

# PowerPAK® 1212-8S D

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Top View

Bottom View

PRODUCT SUMMARY	
V <sub>DS</sub> (V)	-20
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -4.5 V	0.0035
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -2.5 V	0.0052
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -1.8 V	0.0098
Q <sub>g</sub> typ. (nC)	86
I <sub>D</sub> (A)	-111.9
Configuration	Sinale

#### **FEATURES**

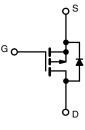
P-Channel 20 V (D-S) MOSFET

TrenchFET<sup>®</sup> Gen III p-channel power MOSFET

- · Leadership R<sub>DS(on)</sub> in compact and thermally enhanced package
- 100 % R<sub>a</sub> and UIS tested
- FREE · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Battery management
- · Load switch



RoHS

COMPLIANT HALOGEN

P-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8S
Lead (Pb)-free and halogen-free	SiSS61DN-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-20 ± 8		
Gate-source voltage		V <sub>GS</sub>			
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-111.9		
	T <sub>C</sub> = 70 °C		-89.6		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-30.9 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		-24.7	А	
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	-200		
Continuous comes duris diada comunit	T <sub>C</sub> = 25 °C	1	-54.8		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	-4.2 <sup>b, c</sup>		
Single pulse avalanche current		I <sub>AS</sub>	-25		
Single pulse avalanche energy L = 0.1 mH		E <sub>AS</sub>	31.2	mJ	
	T <sub>C</sub> = 25 °C		65.8		
	T <sub>C</sub> = 70 °C		42.1	W	
Maximum power dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	5 <sup>b, c</sup>	vv	
	T <sub>A</sub> = 70 °C		3.2 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		
Soldering recommendations (peak temperature) <sup>c</sup>			260	°C	

THERMAL RESISTANCE RATING	às				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b	t ≤ 10 s	R <sub>thJA</sub>	20	25	°C/W
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	1.5	1.9	0/10

Notes

a. T<sub>C</sub> = 25 °C

b. Surface mounted on 1" x 1" FR4 board

t = 10 s C.

d. See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components e.

f. Maximum under steady state conditions is 65 °C/W

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SiSS61DN

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA	-20	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = -10 mA	-	-15.4	-	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	3.3	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.4	-	-0.9	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = ± 8 V	-	-	100	nA
Zara gata valtaga drain avreat		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS}$ = -20 V, $V_{GS}$ = 0 V, $T_{J}$ = 70 °C	-	-	-15	μA
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge$ -10 V, $V_{GS}$ = -10 V	-20	-	-	А
		V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -15 A	-	0.0029	0.0035	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -2.5 V, I <sub>D</sub> = -10 A	-	0.0043	0.0052	Ω
		V <sub>GS</sub> = -1.8 V, I <sub>D</sub> = -5 A	-	0.0070	0.0098	
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -15 A	-	80	-	S
Dynamic <sup>b</sup>						
Input capacitance	C <sub>iss</sub>		-	8740	-	
Output capacitance	C <sub>oss</sub>	$V_{DS}$ = -10 V, $V_{GS}$ = 0 V, f = 1 MHz	-	940	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	860	-	
Tatal asta charge	0	$V_{DS}$ = -10 V, $V_{GS}$ = -8 V, $I_{D}$ = -30.9 A	-	154	231	
Total gate charge	Qg		-	86	129	
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = -10 V, $V_{GS}$ = -4.5 V, $I_{D}$ = -30.9 A	-	17.3	-	nC
Gate-drain charge	Q <sub>gd</sub>		-	18.4	-	1
Gate resistance	Rg	f = 1 MHz	0.32	1.6	3.2	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	15	30	
Rise time	t <sub>r</sub>	$V_{DD}$ = -10 V, $R_L$ = 0.4 $\Omega$ , $I_D \cong$ -24.7 A,	-	10	20	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = -8 V, $R_g$ = 1 $\Omega$	-	90	180	
Fall time	t <sub>f</sub>		-	15	30	
Turn-on delay time	t <sub>d(on)</sub>		-	32	64	ns
Rise time	tr	$V_{DD}$ = -10 V, $R_L$ = 0.4 $\Omega$ , $I_D \cong$ -24.7 A,	-	51	100	]
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = -4.5 V, $R_g$ = 1 $\Omega$	-	106	210	
Fall time	t <sub>f</sub>		-	42	84	
Drain-Source Body Diode Characteristi	cs					
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-54.8	•
Pulse diode forward current	I <sub>SM</sub>		-	-	-200	A
Body diode voltage	V <sub>SD</sub>	$I_{\rm S} = -5$ A, $V_{\rm GS} = 0$ V	-	-0.66	-1.2	V
Body diode reverse recovery time	t <sub>rr</sub>		-	24	80	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = -24.7 A, di/dt = 100 A/μs,	-	13	90	nC
Reverse recovery fall time	ta			11	-	
Reverse recovery rise time	t <sub>b</sub>		-	13	_	ns

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

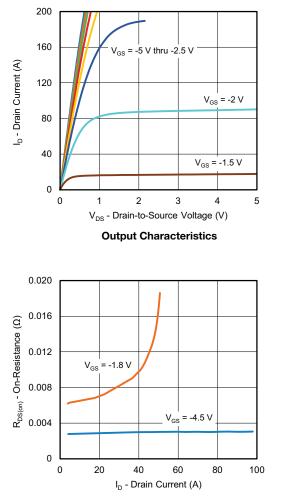
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

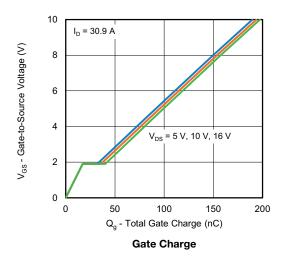
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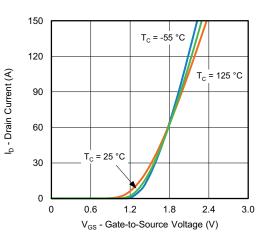


#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

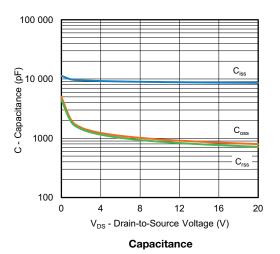


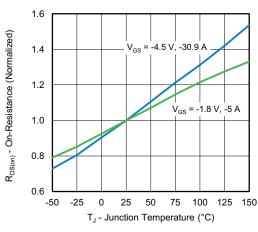
**On-Resistance vs. Drain Current and Gate Voltage** 





**Transfer Characteristics** 





**On-Resistance vs. Junction Temperature** 

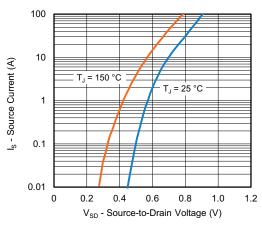
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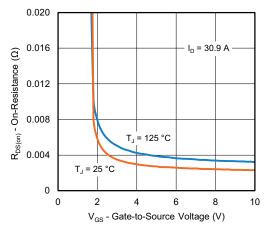
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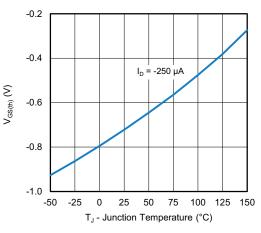
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



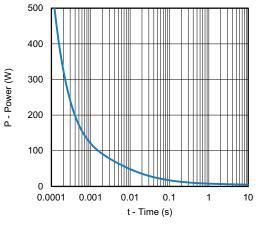
Source-Drain Diode Forward Voltage



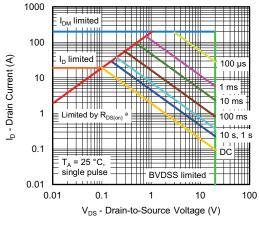
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

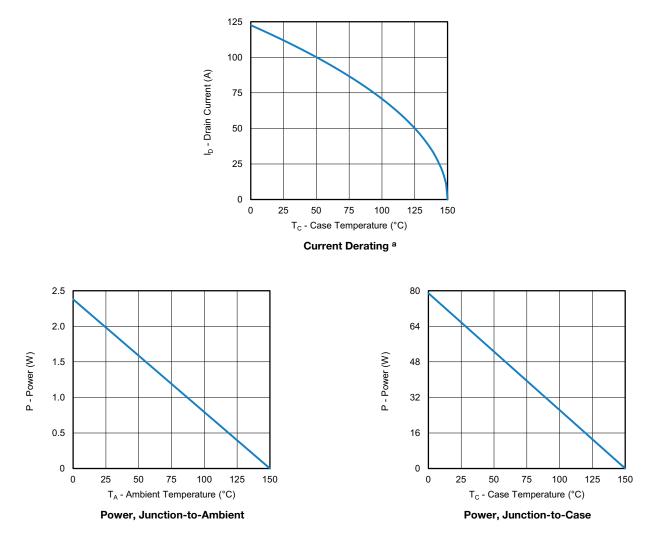
#### Note a. $V_{GS}$ > minimum $V_{GS}$ at which $R_{DS(on)}$ is specified

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

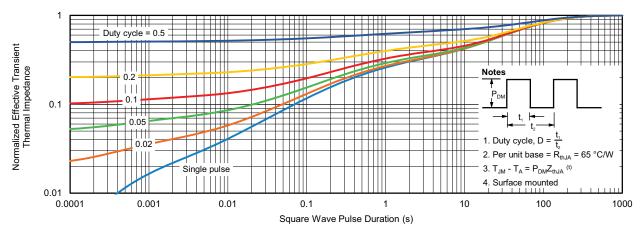


#### Note

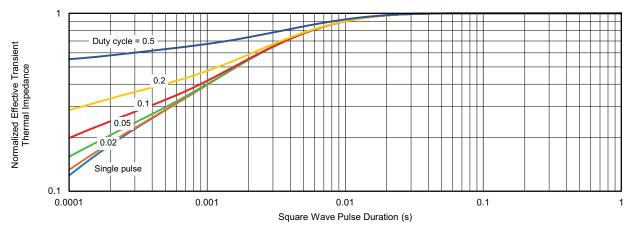
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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## Case Outline for PowerPAK<sup>®</sup> 1212-8S







DIM	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	MIN. NOM.		
А	0.67	0.75	0.83	0.026	0.030	0.033	
A1	0.00	-	0.05	0.000	-	0.002	
A3		0.20 ref.			0.008 ref	•	
b	0.25	0.30	0.35	0.010	0.012	0.014	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	2.15	2.25	2.35	0.085	0.089	0.093	
E	3.20	3.30	3.40	0.126	0.130	0.134	
E1	1.60	1.70	1.80	0.063	0.067	0.071	
е		0.65 bsc.			0.026 bsc.		
К		0.76 ref.			0.030 ref.		
K1		0.41 ref.			0.016 ref.		
L	0.33	0.43	0.53	0.013	0.017	0.021	
Z	0.525 ref.			0.021 ref.			
N: C20-0862-Re /G: 6008	v. B, 20-Jul-2020			•			



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